

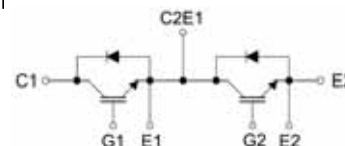
# “HALF-BRIDGE” IGBT MODULE

## Features

- Trench gate + field stopper, using Infineon chip design
- 10μs Short circuit capability
- Low turn-off losses
- Short tail current for over 18KHz
- Positive  $V_{CE(on)}$  temperature coefficient

## Applications

- AC & DC Motor controls
- VVVF inverters
- Optimized for high frequency inverter Type Welding machines
- SMPS
- UPS, Robotics

 $V_{CES} = 1200V$ 
 $I_C = 200A$ 
 $V_{CE(ON)} \text{ typ.} = 1.7V$ 
 $@ I_C = 200A$ 

**Package : V3**


## Absolute Maximum Ratings @ $T_j = 25^\circ C$ (per leg)

| Symbol    | Parameter                        | Condition                       | Ratings        | Unit    |
|-----------|----------------------------------|---------------------------------|----------------|---------|
| $V_{CES}$ | Collector-to-Emitter Voltage     | $V_{GE} = 0V, I_C = 1.0mA$      | 1200           | V       |
| $V_{GES}$ | Gate emitter voltage             |                                 | $\pm 20$       | V       |
| $I_C$     | Continuous Collector Current     | $T_C = 80^\circ C (25^\circ C)$ | 200(260)       | A       |
| $I_{CM}$  | Pulsed collector current         | $T_C = 25^\circ C$              | 400            | A       |
| $I_F$     | Diode Continuous Forward Current | $T_C = 80^\circ C (25^\circ C)$ | 200(260)       | A       |
| $I_{FM}$  | Diode Maximum Forward Current    | $T_C = 25^\circ C$              | 400            | A       |
| $T_{SC}$  | Short Circuit Withstand Time     |                                 | 10             | $\mu s$ |
| $V_{iso}$ | Isolation Voltage test           | AC 1 minute                     | 2500           | V       |
| $T_j$     | Junction Temperature             |                                 | $-40 \sim 150$ |         |
| $T_{stg}$ | Storage Temperature              |                                 | $-40 \sim 125$ |         |
| Weight    | Weight of Module                 |                                 | 360            | g       |
| Mounting  | Power Terminal Screw : M5        |                                 | 3.5            | Nm      |
| Torque    | Terminal connection Screw : M5   |                                 | 3.5            | Nm      |

## Electrical Characteristics @ $T_j = 25^\circ C$ (unless otherwise specified)

| Symbol        | Parameters                              | Min  | Typ | Max       | Unit | Test conditions                   |
|---------------|-----------------------------------------|------|-----|-----------|------|-----------------------------------|
| $V_{(BR)CES}$ | Collector-to-Emitter Breakdown Voltage  | 1200 | -   | -         | V    | $V_{GE} = 0V, I_C = 1.0mA$        |
| $V_{CE(ON)}$  | Collector-to-Emitter Saturation Voltage | 1.4  | 1.7 | 2.15      |      | $I_C = 200A, V_{GE} = 15V$        |
| $V_{GE(th)}$  | Gate Threshold Voltage                  | 5.0  | 5.8 | 6.5       |      | $V_{CE} = V_{GE}, I_C = 500\mu A$ |
| $I_{CES}$     | Zero Gate Voltage Collector Current     | -    | -   | 1.0       | mA   | $V_{GE} = 0V, V_{CE} = 1200V$     |
| $I_{GES}$     | Gate-to-Emitter Leakage Current         | -    | -   | $\pm 200$ | nA   | $V_{CE} = 0V, V_{GE} = \pm 20V$   |

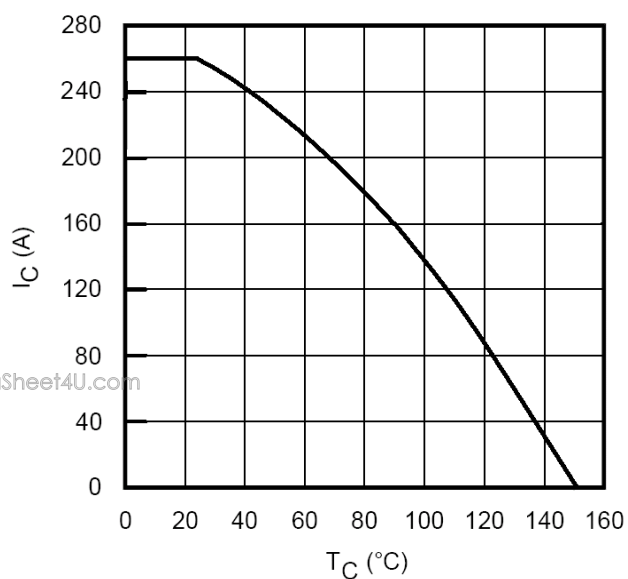
|                 |                            |   |      |      |   |                       |
|-----------------|----------------------------|---|------|------|---|-----------------------|
| V <sub>FM</sub> | Diode Forward Voltage Drop | - | 1.65 | 2.15 | V | I <sub>C</sub> = 200A |
|-----------------|----------------------------|---|------|------|---|-----------------------|

**Switching Characteristic @ T<sub>j</sub> = 25** (unless otherwise specified)

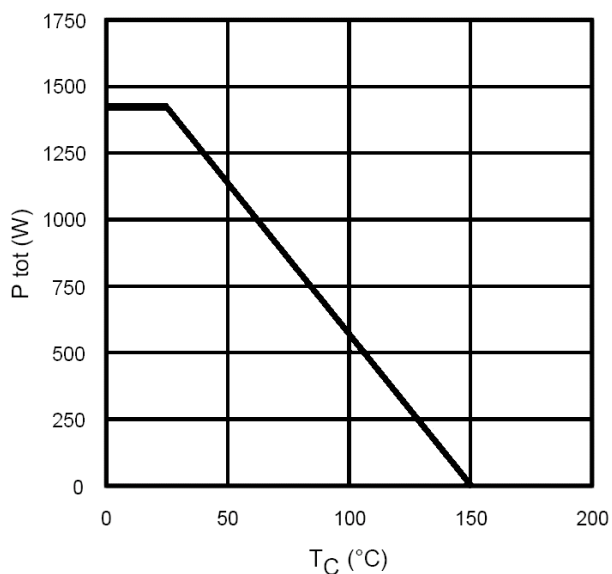
| Symbol              | Parameters                          | Min | Typ   | Max | Unit | Test conditions                                                                                                                        |
|---------------------|-------------------------------------|-----|-------|-----|------|----------------------------------------------------------------------------------------------------------------------------------------|
| C <sub>ies</sub>    | Input capacitance                   | -   | 17306 | -   | pF   | V <sub>CC</sub> = 30V, V <sub>GE</sub> = 0V<br>f = 1.0MHz                                                                              |
| C <sub>oss</sub>    | Output capacitance                  | -   | 810   | -   |      |                                                                                                                                        |
| C <sub>res</sub>    | Reverse transfer capacitance        | -   | 360   | -   |      |                                                                                                                                        |
| t <sub>d(on)</sub>  | Turn-on delay time                  | -   | 300   | -   | ns   | T <sub>j</sub> = 125 , V <sub>CC</sub> = 600V<br>I <sub>C</sub> = 200A, V <sub>GE</sub> = 15V<br>R <sub>G</sub> = 3.6Ω                 |
| t <sub>r</sub>      | Rise time                           | -   | 108   | -   |      |                                                                                                                                        |
| t <sub>d(off)</sub> | Turn-off delay time                 | -   | 660   | -   |      |                                                                                                                                        |
| t <sub>f</sub>      | Fall time                           | -   | 156   | -   |      |                                                                                                                                        |
| I <sub>rr</sub>     | Diode Peak Reverse Recovery current | -   | 160   | -   | A    | T <sub>j</sub> = 125 , V <sub>CC</sub> = 600V<br>I <sub>F</sub> = 200A, V <sub>GE</sub> = 15V<br>R <sub>G</sub> = 3.6Ω, di/dt=1200A/us |
| t <sub>rr</sub>     | Diode Reverse Recovery time         | -   | 250   | -   | ns   |                                                                                                                                        |

**Thermal Characteristic Values**

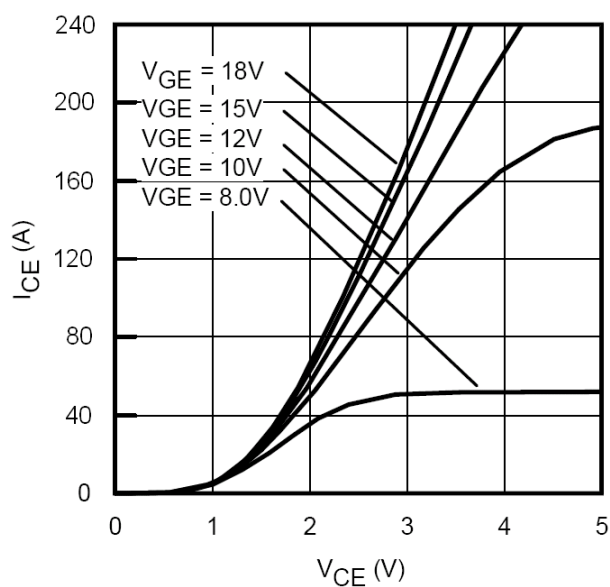
| Symbol           | Parameters                                    | Min | Typ  | Max  | Unit |
|------------------|-----------------------------------------------|-----|------|------|------|
| R <sub>θJC</sub> | Junction-to-Case (IGBT Part, Per 1/2 Module)  | -   | -    | 0.10 | /W   |
| R <sub>θJC</sub> | Junction-to-Case (Diode Part, Per 1/2 Module) | -   | -    | 0.20 |      |
| R <sub>θCS</sub> | Case-to-Heat Sink (Conductive grease applied) | -   | 0.04 | -    |      |



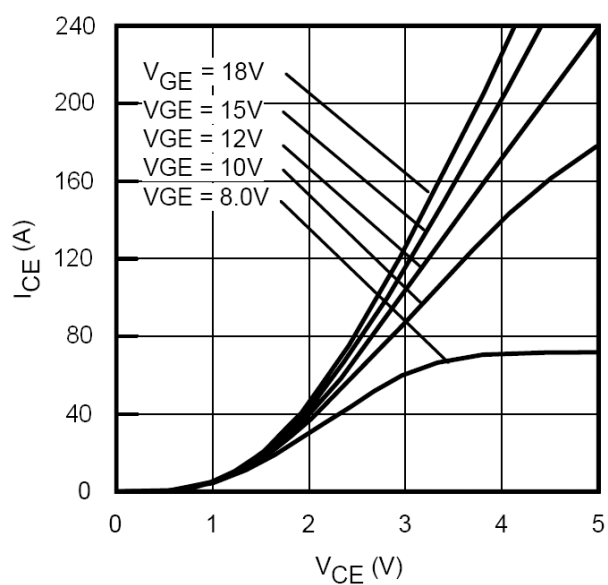
**Fig 1. Maximum DC Collector Current  
vs. Case Temperature**



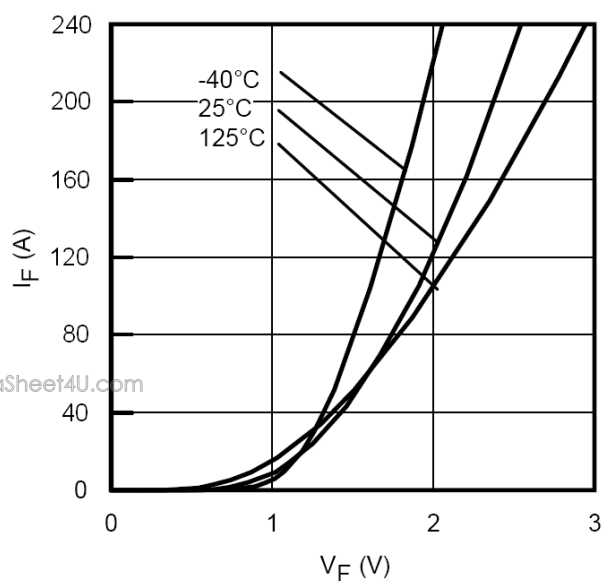
**Fig 2. Power Dissipation vs. Case  
Temperature**



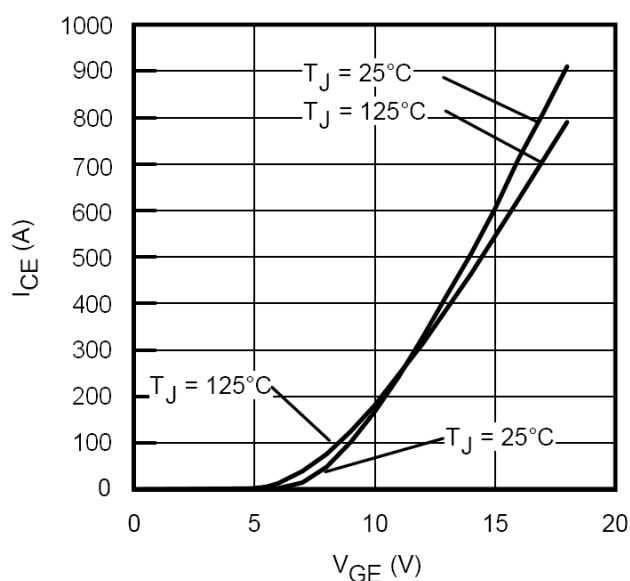
**Fig 3. Typ. IGBT Output Characteristics**  
 $T_J = 25$  ;  $t_p = 80\mu s$



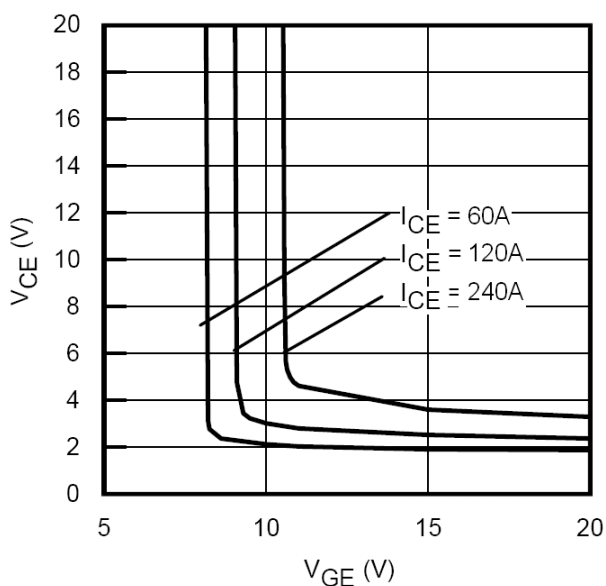
**Fig 4. Typ. IGBT Output Characteristics**  
 $T_J = 125$  ;  $t_p = 80\mu s$



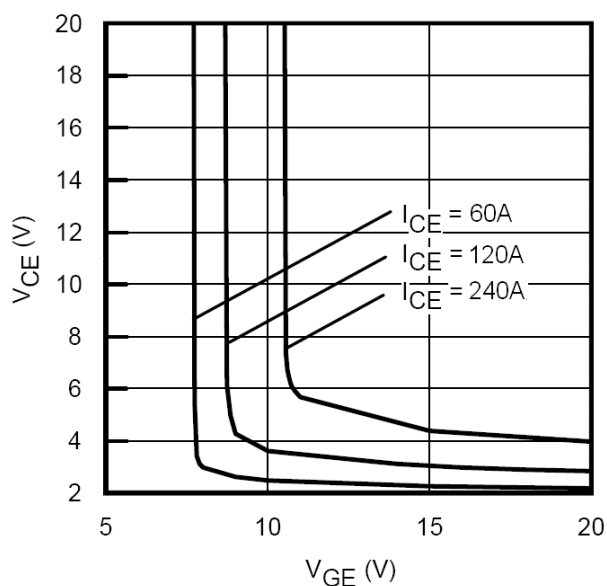
**Fig 5. Typ. Diode Forward Characteristics**  
 $t_p = 80\mu s$



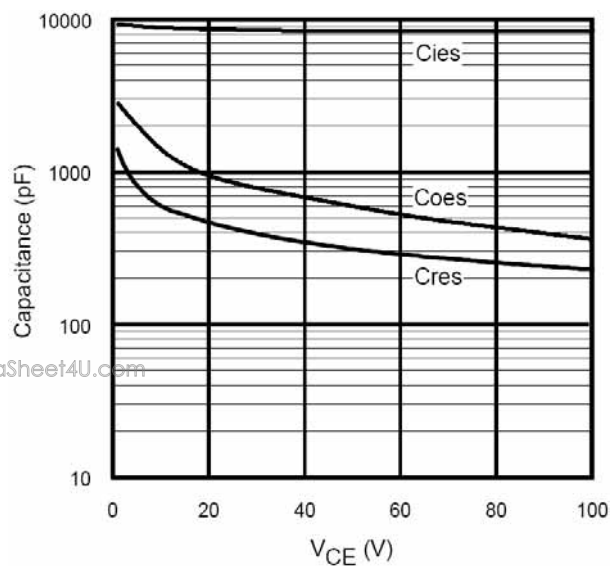
**Fig 6. Typ. Transfer Characteristics**  
 $V_{CE} = 50V$ ;  $t_p = 10\mu s$



**Fig 7. Typical  $V_{CE}$  vs.  $V_{GE}$**   
 $T_J = 25$

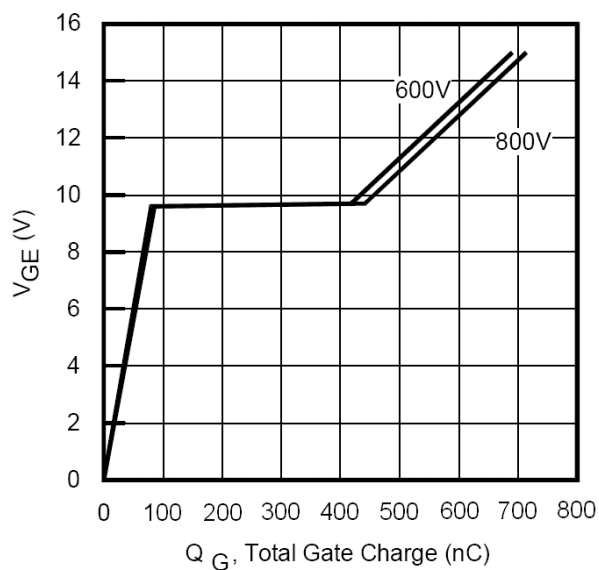


**Fig 8. Typical  $V_{CE}$  vs.  $V_{GE}$**   
 $T_J = 125$



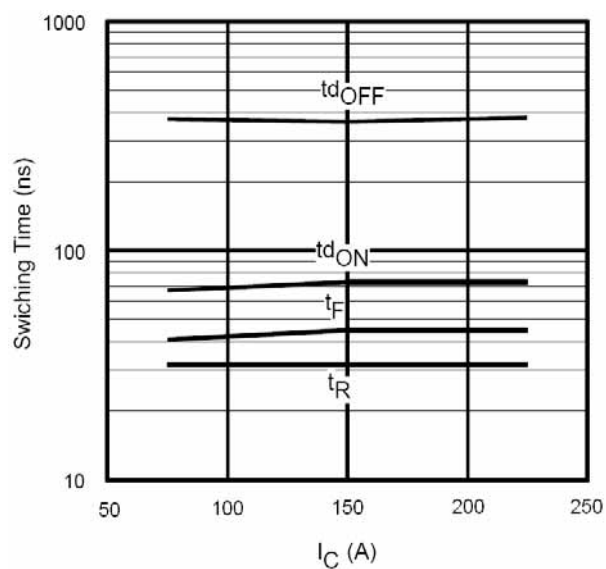
**Fig 9. Typ. Capacitance vs.  $V_{CE}$**

$V_{GE} = 0V$ ;  $f = 1MHz$



**Fig 10. Typical Gate Charge vs.  $V_{GE}$**

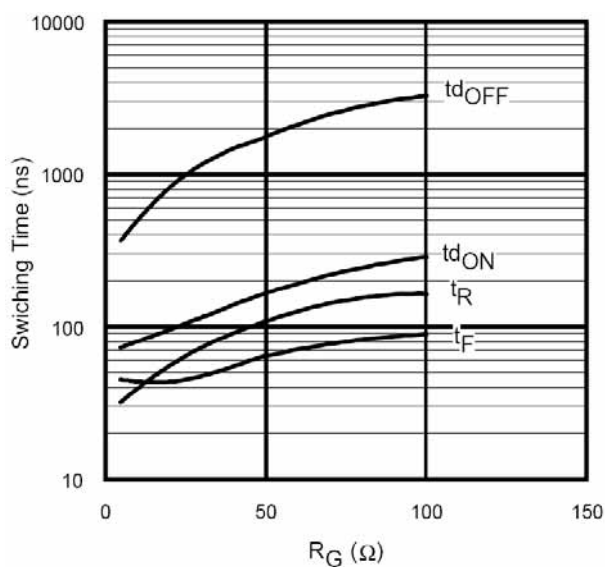
$I_{CE} = 120A$ ;  $L = 600\mu H$



**Fig 11. Typ. Switching Time vs.  $I_C$**

$T_J = 125^\circ C$ ;  $L = 200\mu H$ ;  $V_{CE} = 600V$

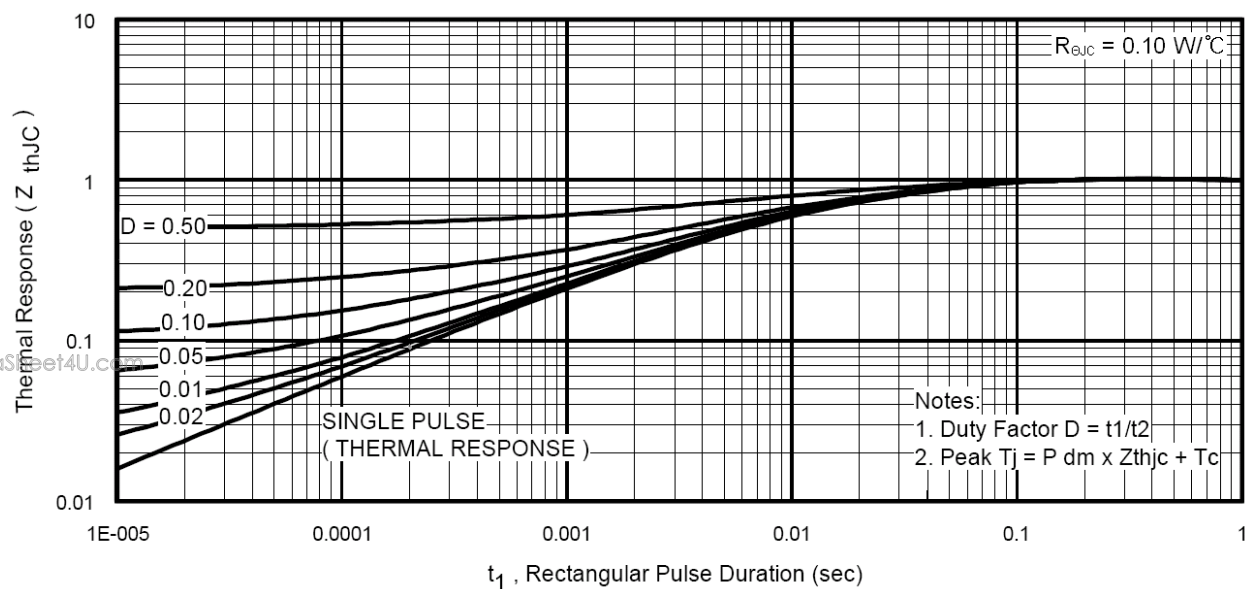
$R_G = 3.9\Omega$ ;  $V_{GE} = 15V$



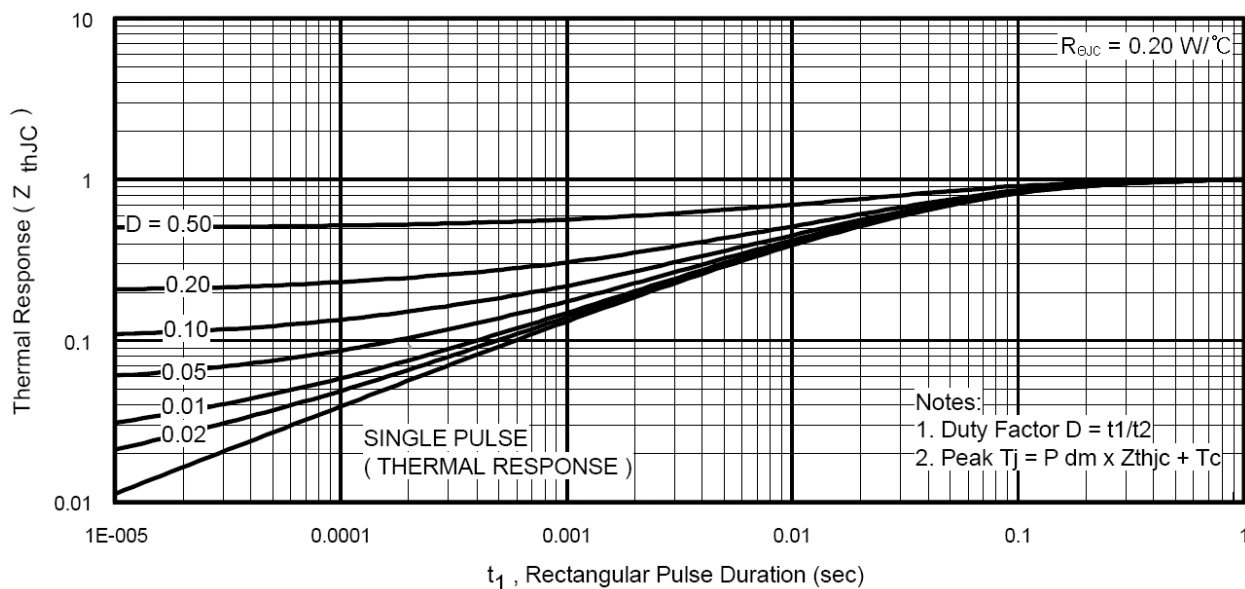
**Fig 12. Typ. Switching Time vs.  $R_G$**

$T_J = 125^\circ C$ ;  $L = 200\mu H$ ;  $V_{CE} = 600V$

$I_{CE} = 200A$ ;  $V_{GE} = 15V$



**Fig 13. Normalized Transient Thermal Impedance, Junction-to-Case (IGBT)**



**Fig 14. Normalized Transient Thermal Impedance, Junction-to-Case (DIODE)**

